O .	FION FORM COVER SHEET U.S. DEPARTMENT OF COMMERCE PATENTS ONLY Patent and Trademark Office Attorney Docket No. 134990		
Please record the attached document. Total number of pages including cover sheet, attachments, and document: 5			
1. A. Name of conveying parties: (1) Hidetaka KAWANO (2) Hiromichi UMEHARA (3) Takamitsu SAKAMOTO (4) Koichi OTANI (5) Noriaki KASAHARA (6) Naoto MATONO B. Additional name(s) of conveying party(ies) at ☐ Yes ☒ No. 3. A. Nature of conveyance:	TO AND TRAINCHANT CONTROL		
☐ Security Agreement ☐ Change of N ☐ Other B. Execution Date: (1-4) February 20, 2 (5-6) February 21, 2	B. Additional name(s) & address(es) attached? Yes No		
4. A. Patent Application No.(s) 12/000,519 Additional numbers attached? ☐ Yes ☒ No C. Title of Application: THIN-FILM MAGNETIC HEAD FOR PERPENDICULAR MAGNETIC			
RECORDING AN 5. Name and address of party to whom correspondence concerning document should be mailed: Name: James A. Oliff Address: OLIFF & BERRIDGE, PLC P.O. Box 320850 Alexandria, VA 22320-4850 Phone Number: 703-836-6400 Fax Number: 703-836-2787	D METHOD OF MAKING THE SAME		
9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Date: February 29, 2008 James A. Oliff, Registration No. 27,075 Kirk D. Berkhimer, Registration No. 59,874			

PATENT REEL: 020587 FRAME: 0339

For Non-U.S. Clients

ASSIGNMENT

Whereas, I/we, Address Address Name 1 (c/o) TDK Corporation, 1) Hidetaka KAWANO 1-13-1, Nihonbashi, Chuo-ku, Tokyo 103-8272 Japan (c/o) TDK Corporation, 2) Hiromichi UMEHARA 1-13-1, Nihonbashi Chuo-ku, Tokyo 103-8272 Japan (c/o) TDK Corporation, 3) Takamitsu SAKAMOTO 1-13-1, Nihonbashi, Chuo-ku, Tokyo 103-8272 Japan (c/o) TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku, Tokyo 103-8272 Japan 4) Koichi OTANI (c/o) TDK Corporation, 1-13-1, Nihonbashi, 5) Noriaki KASAHARA Chuc-ku, Tokyo 103-8272 Japan 6) Naoto MATONO 543, Otai, Saku-shi, Nagano 385-0009 Japan hereinafter called assignor(s), have invented certain improvements in Thin-Film Magnetic Head for Perpendicular Magnetic Recording and Method of Making the Same and executed an application for Letters Patent of the United States of America therefor on even date herewith unless otherwise indicated below: December 13, 2007 Serial No. 12/000519 filed on Whereas TDK Corporation 1-13-1, Nihonbashi, Chuo-ku, Tokyo 103-8272 Japan and. SAE Magnetics (H.K.) LTD. SAE Technology Centre, 6 Science Park East Avenue, Hong Kong Science Park, Shatin, N.T. China (assignee), desires to acquire the entire right, title and interest in the application and invention, and to any United States patents to be obtained therefor; NOW THEREFORE, be it known that, for good and valuable consideration from assignee, the receipt of which is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment; AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns. **INVENTORS** DATE SIGNED Hidetaka Kawano 1): Hidetaka KAWANO Name: 2): <u>. V ine hero.</u> Hiromichi UMEHARA Name:

(Legalization not required for recording but is prima facie evidence of execution under 35 U.S.C. § 261)

REEL: 020587 FRAME: 0340

3):	Takamitsu Sakamoto	Feb 20/2007
Name:	Takamitsu SAKAMOTO	
4):	Koichi Otani	Feb 20/208
Name:	Kolchi OTANI	
5):	Moriaki Kasahara Noriaki KASAHARA	Feb 21/2008
Name:	Noriaki KASAHARA	
6):		•
Name:	Nacto MATONO	

2):

For Non-U.S. Clients ASSIGNMENT Whereas, I/we, Address N<u>ame</u> (c/o) TDK Corporation, 1) Hidetaka KAWANO 1-13-1, Nihonbashi, Chuo-ku, Tokyo 103-8272 Japan (c/p) TDK Corporation, 2) Hiromichi UMEHARA 1-13-1, Nihonbashi, Chuo-ku, Tokyo 103-8272 Japan (c/o) TDK Corporation, 1-13-1, Nihonbashi, 3) Takamitsu SAKAMOTO Chuo-ku, Tokyo 103-8272 Japan (c/o) TDK Corporation, 1-13-1, Nihonbashi, 4) Koichl OTANI Chuo-ku, Tokyo 103-8272 Japan (c/o) TDK Corporation. 5) Noriaki KASAHARA 1-13-1, Nihonbashi, Chuo-ku, Tokyo 103-8272 Japan 543. Otal. 6) Naoto MATONO Saku-shi, Nagano 385-0009 Japan hereinafter called assignor(s), have invented certain improvements in Thin-Film Magnetic Head for Perpendicular Magnetic Recording and Method of Making the Same and executed an application for Letters Patent of the United States of America therefor on even date herewith unless otherwise indicated below: 12/000519 December 13, 2007, Serial No. _ _; and filed on Whereas TDK Corporation 1-13-1, Nihonbashi, Chuo-ku, Tokyo 103-8272 Japan and. SAE Magnetics (H.K.) LTD. SAE Technology Centre, 6 Science Park East Avenue, Hong Kong Science Park, Shatin, N.T. China (assignee), desires to acquire the entire right, title and interest in the application and invention, and to any United States patents to be obtained therefor; NOW THEREFORE, be it known that, for good and valuable consideration from assignee, the receipt of which is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment; AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns. **DATE SIGNED** INVENTORS 1):

Hidetaka KAWANO Name: Hiromichi UMEHARA Name:

(Legalization not required for recording but is prima facie evidence of execution under 35 U.S.C. § 261)

3):		
Name:	Takamitsu SAKAMOTO	
4): Name:	Koichi OTANI	
5): Name:	Noriaki KASAHARA	
6): Name:	Naoto MATONO	/26. 2/, OF

(Legalization not required for recording but is prima facie evidence of execution under 35 U.S.C. § 261)